

ESD Protection Diodes Silicon Epitaxial Planar

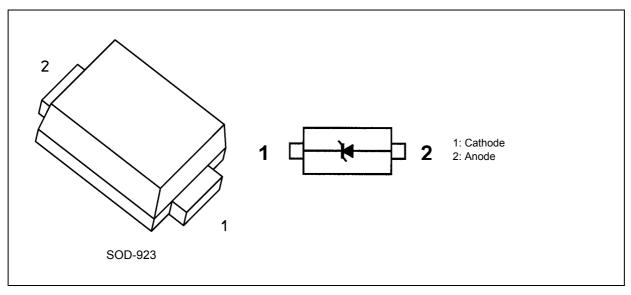
# DF2S6.8MFS

### 1. Applications

· ESD Protection

Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

### 2. Packaging and Internal Circuit



## 3. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25°C)

| Characteristics   | Symbol           | ol Rating  |    |
|---|------------------|------------|----|
| Electrostatic discharge voltage (IEC61000-4-2)(Contact) | V <sub>ESD</sub> | ±12        | kV |
| Electrostatic discharge voltage(IEC61000-4-2)(Air)      | V <sub>ESD</sub> | ±15        | kV |
| Peak pulse power  | P <sub>PK</sub>  | 45         | W  |
| Peak pulse current                                      | I <sub>PP</sub>  | 3          | Α  |
| Junction temperature                                    | Tj               | 150        | °C |
| Storage temperature                                     | T <sub>stg</sub> | -55 to 150 | °C |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production



## 4. Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

 $V_{\text{RWM}}$ : Working peak reverse voltage

V<sub>BR</sub>: Reverse breakdown voltage I<sub>BR</sub>: Reverse breakdown current

I<sub>R</sub>: Reverse current V<sub>C</sub>: Clamp voltage I<sub>PP</sub>: Peak pulse current R<sub>DYN</sub>: Dynamic resistance I<sub>F</sub>: Forward current V<sub>F</sub>: Forward voltage

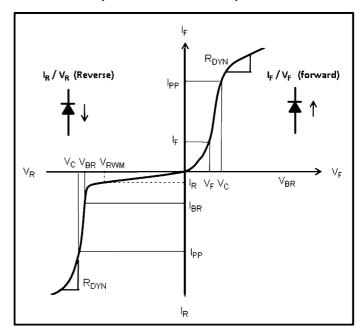


Fig. 4.1 Definitions of Electrical Characteristics

| Characteristics              | Symbol           | Note     | Test Condition                  | Min | Тур. | Max | Unit |
|------------------------------|------------------|----------|---------------------------------|-----|------|-----|------|
| Working peak reverse voltage | $V_{RWM}$        |          | _                               | _   | _    | 5.0 | V    |
| Reverse breakdown voltage    | $V_{BR}$         |          | I <sub>BR</sub> = 5 mA          | 6.0 | _    | _   | V    |
| Reverse current              | $I_R$            |          | V <sub>RWM</sub> = 5 V          | _   | _    | 0.5 | μΑ   |
| Clamp voltage                | V <sub>C</sub>   | (Note 1) | I <sub>PP</sub> = 1 A           | _   | 9.5  | _   | V    |
|                              |                  |          | I <sub>PP</sub> = 3 A           | _   | 12   | 15  |      |
| Clamp voltage                | V <sub>C</sub>   | (Note 2) | I <sub>TLP</sub> = 16 A         | _   | 14.5 | _   |      |
|                              |                  |          | I <sub>TLP</sub> = 25 A         | _   | 17.7 | _   |      |
| Dynamic resistance           | R <sub>DYN</sub> | (Note 2) | _                               | _   | 0.35 | _   | Ω    |
| Total capacitance            | Ct               | (Note 3) | V <sub>R</sub> = 0 V, f = 1 MHz | _   | 0.45 | 0.9 | pF   |

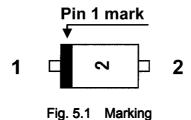
Note 1: Based on IEC61000-4-5 8/20  $\mu s$  pulse.

Note 2: TLP parameter: Z0 = 50  $\Omega$ , tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns, extraction of dynamic resistance using a least-squares fit of TLP characteristics at IPP between 8 A to 16 A.

Note 3: Guaranteed by design.



## 5. Marking



## 6. Land Pattern Dimensions (for reference only)

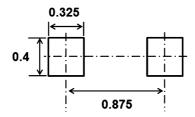
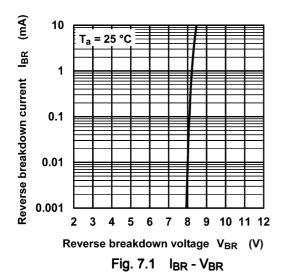
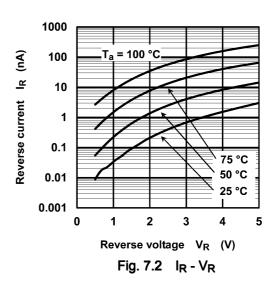
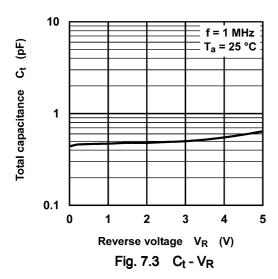


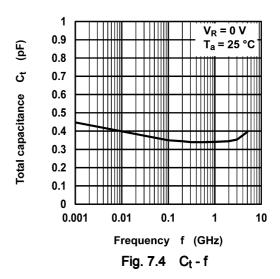
Fig. 6.1 Land Pattern Dimensions (Unit: mm)

## 7. Characteristics Curves (Note)









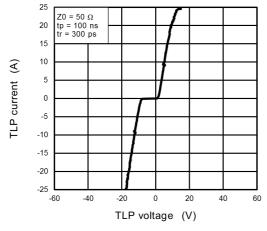
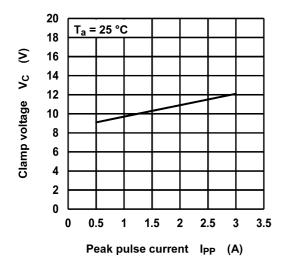


Fig. 7.5 TLP

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

## 8. Clamp Voltage - Peak Pulse Current (V<sub>C</sub> - I<sub>PP</sub>) (Note)



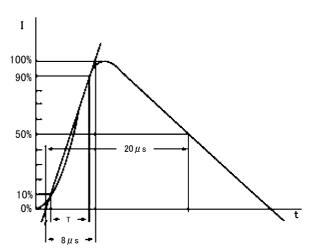
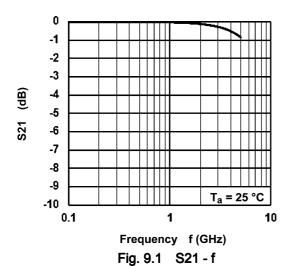


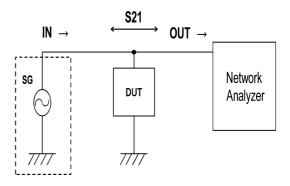
Fig. 8.1 V<sub>C</sub> - I<sub>PP</sub>

Fig. 8.2 Based on IEC61000-4-5 8/20  $\mu$ s pulse.

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### 9. Insertion Loss (S21) (Note)

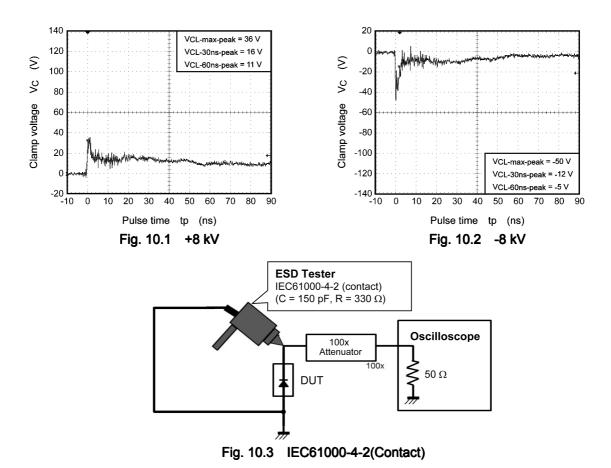




Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## 10. ESD Clamp Waveform (Note)

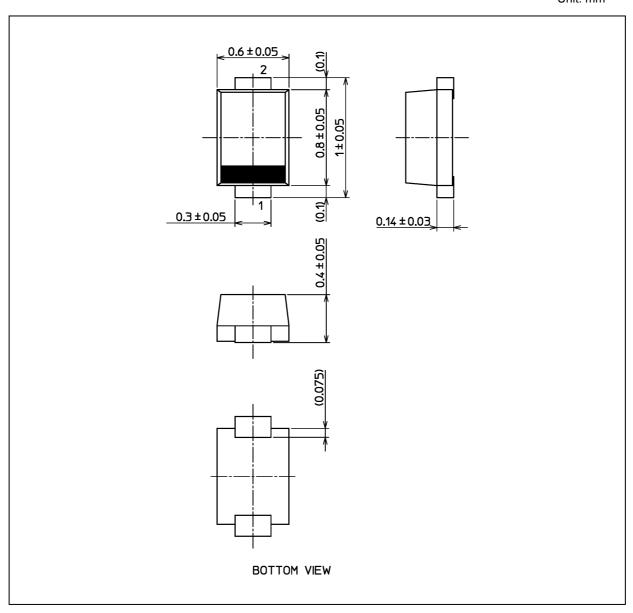


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## **Package Dimensions**

Unit: mm



Weight: 0.55 mg (typ.)

| Package Name(s)   |  |  |  |  |  |
|-------------------|--|--|--|--|--|
| Nickname: SOD-923 |  |  |  |  |  |

Rev.6.0



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